	DOCKEU	TITLE	INVENTORS	· AMOUNT	PARENT NO
1	ZE017	Printhead assembly incorporating one or more printhead modules	Kia Silverbrook, Tobin Allen King	850.00	ART108
2	ZE018	Printhead assembly incorporating a channel member	Kia Silverbrook, Tobin Allen King	850.00	ART108
3	ZE019	Printhead assembly incorporating an elastomeric feed member	Kia Silverbrook, Tobin Allen King	850.00	ART108
4	ZE020	Printhead assembly incorporating micromoldings	Kia Silverbrook, Tobin Allen King	850.00	ART108
5	BAL70	A camera for printing manipulated images	Kia Silverbrook, Paul Lapstun, Simon Robert Walmsley	998.00	ART51
6	BAL71	A camera for pirnting on media provided on print roll	Walmsley Kia Silverbrook, Paul Lapstun, Simon Robert	1,142.00	ART51
7	BAL72	A camera for printing manipulated images on media	Walmslev Kia Silverbrook, Paul Lapstun, Simon Robert Walmslev	1,070.00	ART51
8	BAL73	A camera and controlling processing system	Kia Silverbrook, Paul Lapstun, Simon Robert Walmsley	1,070.00	ART51
9	ZE009	A method of fabricating a fluid ejection device using a planarizing step	Kia Silverbrook	810.00	IJ46 Div. 2
10	ZE010	A micro-electromechanical fluid ejection device with control logic circuitry	Kia Silverbrook	810.00	IJ46 Div. 2
11	ZE011	A printhead configuration incorporating a nozzle arrangement layout	Kia Silverbrook	810.00	IJ46 Div. 2
12	ZE012	A method of fabricating a micro-electromechanical device having a laminated actuator	Kia Silverbrook	810.00	IJ46 Div. 2
13	ZF189	An image capture and processing device for a print on demand digital camera system	Kia Silverbrook	810.00	IR18
14	ZF190	A printhead assembly for a print on demand digital camera system	Kia Silverbrook	810.00	IR18
15	ZF191	A printhead re-capping assembly for a print on demand digital camera system	Kia Silverbrook	810.00	IR18
16	MTB05	Ink Jet printhead with circular cross section chamber	Kia Silverbrook	1,044.00	MJ40
17	MTB07	Ink jet printhead with amorphous ceramic chamber	Kia Silverbrook	1,116.00	MJ40
18	ZF132	Composite support beam for pirnthead assembly	Kia Silverbrook	810.00	MJ44
19	ZF133	Thermal expansion relief for printhead assembly	Kia Silverbrook	810.00	MJ44
20	ZF134	Thermal expansion compensation for printhead assembly	Kia Silverbrook	810.00	MJ44
21	ZE013	A micro-electromechanical fluid ejection device having a chamber that is volumetrically altered for fluid ejection	Kia Silverbrook	810.00	MJ95
22	ZE014	A micro-electromechanical fluid ejection device having a nozzle guard	Kia Silverbrook	810.00	MJ95
23	MTB01	Thermal ink jet printhead with short heater to nozzle aperture distance	Kia Silverbrook	1,422.00	MJT001
24	MTB012	Thermal ink jet printhead with low resistance electrodes for heaters	Kia Silverbrook	1,422.00	MJT001
25		Thermal ink jet printhead with heater elements supported by electrodes	Kia Silverbrook	1,422.00	MJT001

26	MTB02	Very high efficiency thermal ink jet printhead	Kia Silverbrook, Angust		<del></del>
		very riigh entolency thermal link jet printhead	John North, Gregory John McAvov	1,502.00	MJT001
27	MTB03	Low voltage thermal ink jet printhead	Kia Silverbrook	1,422.00	MJT001
28	MTB04	Inkjet printhead with low mass displacement nozzle  Thermal ink jet printhead with bubble collapse point close to nozzle aperture  Heat dissipation within thermal ink jet printhead	Kia Silverbrook	1,422.00	MJT001
29	мтво6		Kia Silverbrook	1,422.00	MJT001
30	MTB14		Kia Silverbrook	1,422.00	MJT001
31	ZF184	Ink Distribution assembly	Kia Silverbrook	810.00	PAK12
32	ZG185	Printhead chassis assembly	Kia Silverbrook	810.00	PAK12
33	ZG186	Laminated distribution structure	Kia Silverbrook	810.00	PAK12
34	ZG112	Chips with wafer scale caps formed by molding	Kia Silverbrook	810.00	WSM01
35	ZG113	Two part mold for wafer scale caps	Kia Silverbrook	810.00	WSM01
36	ZG114	Wafer scale caps located by molding	Kia Silverbrook	810.00	WSM01
37	ZG115	Molded wafer scale cap array	Kia Silverbrook	810.00	WSM01
38	ZG116	Placement tool for wafer scale caps	Kia Silverbrook	810.00	WSM01
39	ZG117	Mold making method for wafer scale caps	Kia Silverbrook	810.00	WSM01
40	ZG118	Chip with molded cap array	Kia Silverbrook	810.00	WSM01
41	ZG119	Molded wafer scale cap	Kia Silverbrook	810.00	WSM01
42	ZF117	Thermoelastic inkjet actuator with heat conductive pathways	Kia Silverbrook, Gregory John McAvoy	850.00	YU185
43	ZE005	An ink jet printhead chip having an actuator mechanisms located about ejection ports	Kia Silverbrook, Gregory John McAvoy	850.00	YU195
44	ZE006	A method of fabricating an ink jet printhead chip having actuator mechanisms located about ejection ports	Kia Silverbrook, Gregory John McAvoy	850.00	YU195
45	ZE007	A micro-electromechanical fluid ejection device having actuator mechanisms located about ejection ports	Kia Silverbrook, Gregory John McAvoy 85		YU195
46	ZE008	A micro-electromechanical fluid ejection device having nozzle chambers with diverging walls	Kia Silverbrook, Gregory John McAvoy 850.00		YU195
47	ZG187	Page binder with air cushion and non-contact adhesive applicator	Kia Silverbrook 850.00		ZF107
48	ZG188	Page binder with adhesive applicator for gluing traling edge of pages	Kia Silverbrook	850.00	ZF107
49	ZG189	Page binder with two part adhesive applicator	Kia Silverbrook	850.00	ZF107
50	МТВ08	Inkjet printhead with ink supply passage to nozzle etched from opposing sides of wafer	Kia Silverbrook	1,170.00	ZF121

57			,	51,520.00	
56					
53	MTB11	Inkjet printhead with ink supply passage formed from both sides of the wafer by overlapping etches	Kia Silverbrook	1,256.00	ZF121
52	МТВ10	Inkjet printhead with ink chamber inlet etched into wafer	Kia Silverbrook	1,256.00	ZF121
51	мтво9	Inkjet printhead with non-uniform width ink supply passage to nozzle	Kia Silverbrook	1,112.00	ZF121